

IN THE CLAIMS

A listing of the claims presented in this patent application appears below. This listing replaces all prior versions and listing of claims in this patent application.

1. (Original) An electrical contact comprising an Ag alloy containing Sn in an amount of from 1 to 9% by weight and Cd in an amount of 0% by weight, inclusive, to less than 0.01% by weight and having a two-layer structure composed of a first layer on a surface side thereof and a second layer on an inner side thereof, wherein the first layer has an average hardness of 150 or more on the microvickers scale defined by JIS and a thickness of 10 μm or more and the second layer has an average hardness of more than 130 on the microvickers scale.
2. (Original) The electrical contact as described in Claim 1, wherein the average hardness of the aforesaid first layer is 190 or more on the aforesaid scale.
3. (Currently Amended) The electrical contact as described in Claim 1 ~~or 2~~, wherein In is incorporated therein in an amount of from 1% to 9% by weight in addition to Sn.
4. (Currently Amended) The electrical contact as described in ~~any one of Claims 1 to 3~~ Claim 1, wherein as additive components other than Sn and In there are incorporated at least one selected from the group of elements consisting of Sb, Ca, Bi, Ni, Co, Zn, Cu, Mo, W, Ge, Te, Cr and Pb.
5. (Currently Amended) An electrical apparatus using an electrical contact as described in ~~any one of Claims 1 to 4~~ Claim 1.
6. (New) An electrical apparatus using an electrical contact as described in Claim 2.
7. (New) An electrical apparatus using an electrical contact as described in Claim 3.
8. (New) An electrical apparatus using an electrical contact as described in Claim 4.